

Halogens free devices



**CHENMKO ENTERPRISE CO.,LTD**

**SURFACE MOUNT**

**Dual P-Channel Enhancement Mode Field Effect Transistor**

VOLTAGE 20 Volts CURRENT 0.5 Ampere

**CHM1023VGP**

**FEATURE**

- \* Small surface mounting type. (SOT-563)
- \* High density cell design for low R<sub>DS(ON)</sub>.
- \* Suitable for high packing density.

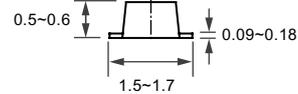
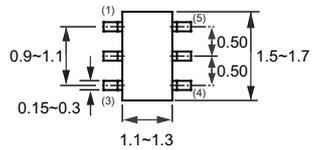
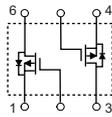
**CONSTRUCTION**

- \* P-Channel Enhancement



SOT-563

**CIRCUIT**



Dimensions in millimeters

SOT-563

**Absolute Maximum Ratings** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	CHM1023VGP	Units
V <sub>DSS</sub>	Drain-Source Voltage	-20	V
V <sub>GSS</sub>	Gate-Source Voltage - Continuous	±12	V
I <sub>D</sub>	Maximum Drain Current - Continuous	-0.5	A
P <sub>D</sub>	Maximum Power Dissipation	350	mW
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to 150	°C

## RATING CHARACTERISTIC CURVES ( CHM1023VGP )

**Electrical Characteristics**  $T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
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### OFF CHARACTERISTICS

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = -250\ \mu\text{A}$	-20			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = -20\text{ V}, V_{GS} = 0\text{ V}$			-1	$\mu\text{A}$
		$V_{DS} = -20\text{ V}, T_j = 55^\circ\text{C}$			-5	$\mu\text{A}$
$I_{GSSF}$	Gate - Body Leakage, Forward	$V_{GS} = 12\text{ V}, V_{DS} = 0\text{ V}$			100	nA
$I_{GSSR}$	Gate - Body Leakage, Reverse	$V_{GS} = -12\text{ V}, V_{DS} = 0\text{ V}$			-100	nA

### ON CHARACTERISTICS (Note 1)

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 1.0\text{ mA}$	-0.35		-0.8	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS} = -4.5\text{ V}, I_D = -0.45\text{ A}$			0.52	$\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = -10\text{ V}, I_D = -250\text{ mA}$		0.4		S

### DYNAMIC CHARACTERISTICS

$Q_g$	Total Gate Charge	$V_{DS} = -10\text{ V}, V_{GS} = -4.5\text{ V}, I_D = -0.6\text{ A}$		1.5	2.0	nC
$Q_{gs}$	Gate-Source Charge			0.3		
$Q_{gd}$	Gate-Drain Charge			0.35		
$t_{on}$	Turn-On Time	$V_{DD} = -10\text{ V}, I_D = -400\text{ mA}, V_{GS} = -4.5\text{ V}, R_{GEN} = 6\ \Omega$			10	nS
$t_{off}$	Turn-Off Time				15	